Si4434ADY

RoHS

COMPLIANT

HALOGEN

FREE

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Vishay Siliconix



Marking code: 4848A

PRODUCT SUMMARY					
V _{DS} (V)	250				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.150				
$R_{DS(on)}$ max. (Ω) at V_GS = 7.5 V	0.170				
Q _g typ. (nC)	8.6				
I _D (A) ^d	4.1				
Configuration	Single				

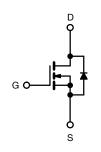
FEATURES

N-Channel 250 V (D-S) MOSFET

- ThunderFET® power MOSFET
- 100 % R_g tested
- Material categorization for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- DC/DC converters
- Boost converters
- LED backlighting
- PD switch
- Load switch



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4434ADY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	250	V	
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		4.1		
Continuous drein surrent (T 150 °C)	T _C = 70 °C		3.3		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	2.8 ^{a, b}		
	T _A = 70 °C		2.3 ^{a, b}	•	
Pulsed drain current (t = 100 μs)		I _{DM}	25	— A	
Continuous source-drain diode current	T _C = 25 °C	- I _S	5		
	T _A = 25 °C		2.4 ^{a, b}		
Single pulse avalanche current		I _{AS}	12		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	7.2	mJ	
Maximum power dissipation	T _C = 25 °C		6		
	T _C = 70 °C		3.8	244	
	T _A = 25 °C	PD	2.9 ^{a, b}	W	
	T _A = 70 °C	1	1.9 ^{a, b}		
Operating junction and storage temperature range		TJ, T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient a, c	t ≤ 10 s	R _{thJA}	36	43	°C/W		
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	16	21	- C/W		

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. Maximum under steady state conditions is 84 °C/W

d. T_C = 25 °C

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	250	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050	-	254	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μΑ	-	-6.9	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{DS} = 250 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 250 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 10$ V, $V_{GS} = 10$ V	10	-	-	Α
		V _{GS} = 10 V, I _D = 2.8 A	-	0.125	0.150	<u> </u>
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 2.7 A	-	0.135	0.170	Ω
Forward transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 2.8 A	-	10	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	600	-	pF
Output capacitance	C _{oss}	V _{DS} = 125 V, V _{GS} = 0 V, f = 1 MHz	-	65	-	
Reverse transfer capacitance	C _{rss}		-	2	-	
•		V _{DS} = 125 V, V _{GS} = 10 V, I _D = 2 A	-	10.9	16.5	_
Total gate charge	Qg		-	8.6	12.9	1
Gate-source charge	Q _{gs}	$V_{DS} = 125 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 2 \text{ A}$	-	2.7	-	nC
Gate-drain charge	Q _{qd}		-	2.9	-	
Output charge	Q _{oss}	V _{DS} = 125 V, V _{GS} = 0 V	-	30	45	1
Gate resistance	Rq	f = 1 MHz	0.5	2.3	4.6	Ω
Turn-on delay time	t _{d(on)}		-	8	16	
Rise time	t _r	$V_{DD} = 125 \text{ V}, \text{ R}_{\text{L}} = 54.4 \Omega, \text{ I}_{D} \cong 2.3 \text{ A},$	-	22	35	1
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	18	30	1
Fall time	t _f		-	22	35	1
Turn-on delay time	t _{d(on)}		-	10	20	ns
Rise time	tr	$V_{DD} = 125 \text{ V}, \text{ R}_{L} = 54.4 \Omega, \text{ I}_{D} \cong 2.3 \text{ A},$	-	22	40	-
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = 7.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	18	30	
Fall time	t _f		-	25	50	1
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	5	Ι.
Pulse diode forward current	I _{SM}	-	-	-	25	A
Body diode voltage	V _{SD}	I _S = 2.3 A, V _{GS} = 0 V	-	0.8	1.2	V
Body diode reverse recovery time	t _{rr}		-	100	150	ns
Body diode reverse recovery charge	Q _{rr}		-	356	550	nC
Reverse recovery fall time	ta	$I_F = 2.3 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$	-	65	-	1
Reverse recovery rise time	t _b		_	35	_	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

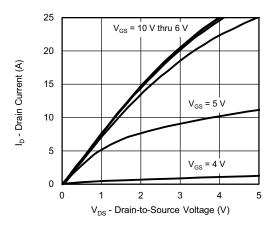
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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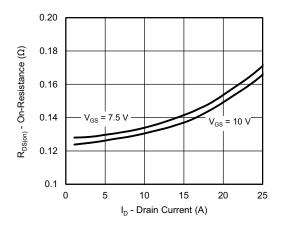


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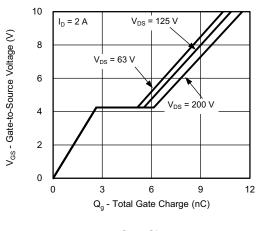
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



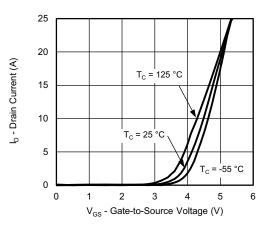
Output Characteristics



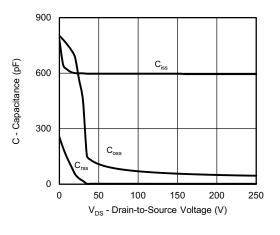
On-Resistance vs. Drain Current and Gate Voltage



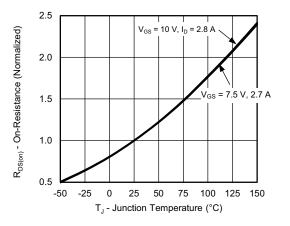
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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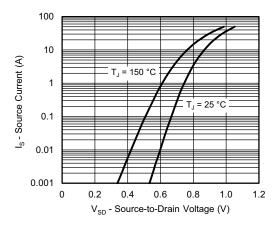
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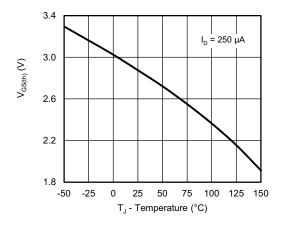


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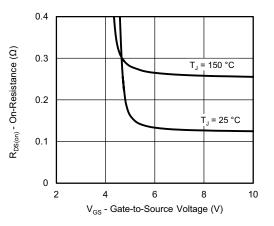
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



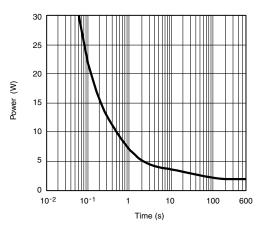
Source-Drain Diode Forward Voltage



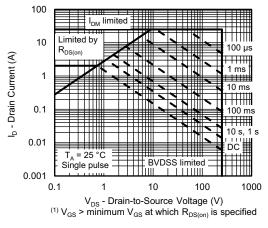
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

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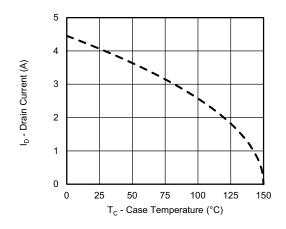
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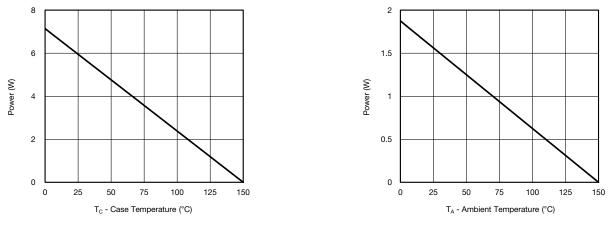


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating ^a

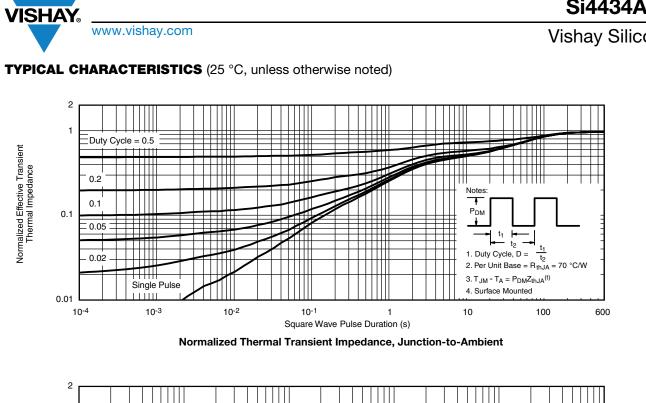


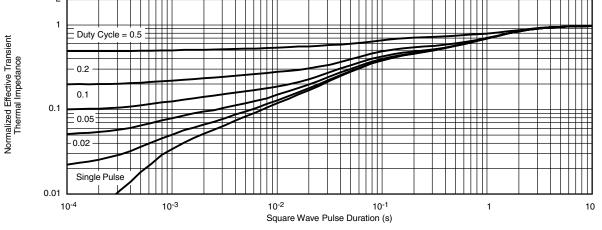
Power, Junction-to-Case

Power, Junction-to-Ambient

Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76230.

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Package Information

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	CHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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